

HIGH COLLECTOR TO EMITTER VOLTAGE HIGH ISOLATION VOLTAGE MULTI PHOTOCOUPLER SERIES

—NEPOC™ Series—

DESCRIPTION

The PS2534-1, -2, -4, PS2534L-1, -2, -4, PS2535-1, -2, -4 and PS2535L-1, -2, -4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon darlington connected phototransistor.

The PS2534-1, -2, -4 and PS2535-1, -2, -4 are in a plastic DIP (Dual In-line Package) and the PS2534L-1, -2, -4 and PS2535L-1, -2, -4 are lead bending type (Gull-wing) for surface mount.

FEATURES

- High collector to emitter voltage ($V_{CEO} = 300\text{ V}$: PS2534-1, -2, -4, PS2534L-1, -2, -4)
($V_{CEO} = 350\text{ V}$: PS2535-1, -2, -4, PS2535L-1, -2, -4)
- High isolation voltage ($BV = 5\,000\text{ V r.m.s.}$)
- High current transfer ratio ($CTR = 1\,500\% \text{ TYP.}$)
- Ordering number of taping product: PS2534L-1-E3, E4, F3, F4, PS2534L-2-E3, E4
PS2535L-1-E3, E4, F3, F4, PS2535L-2-E3, E4

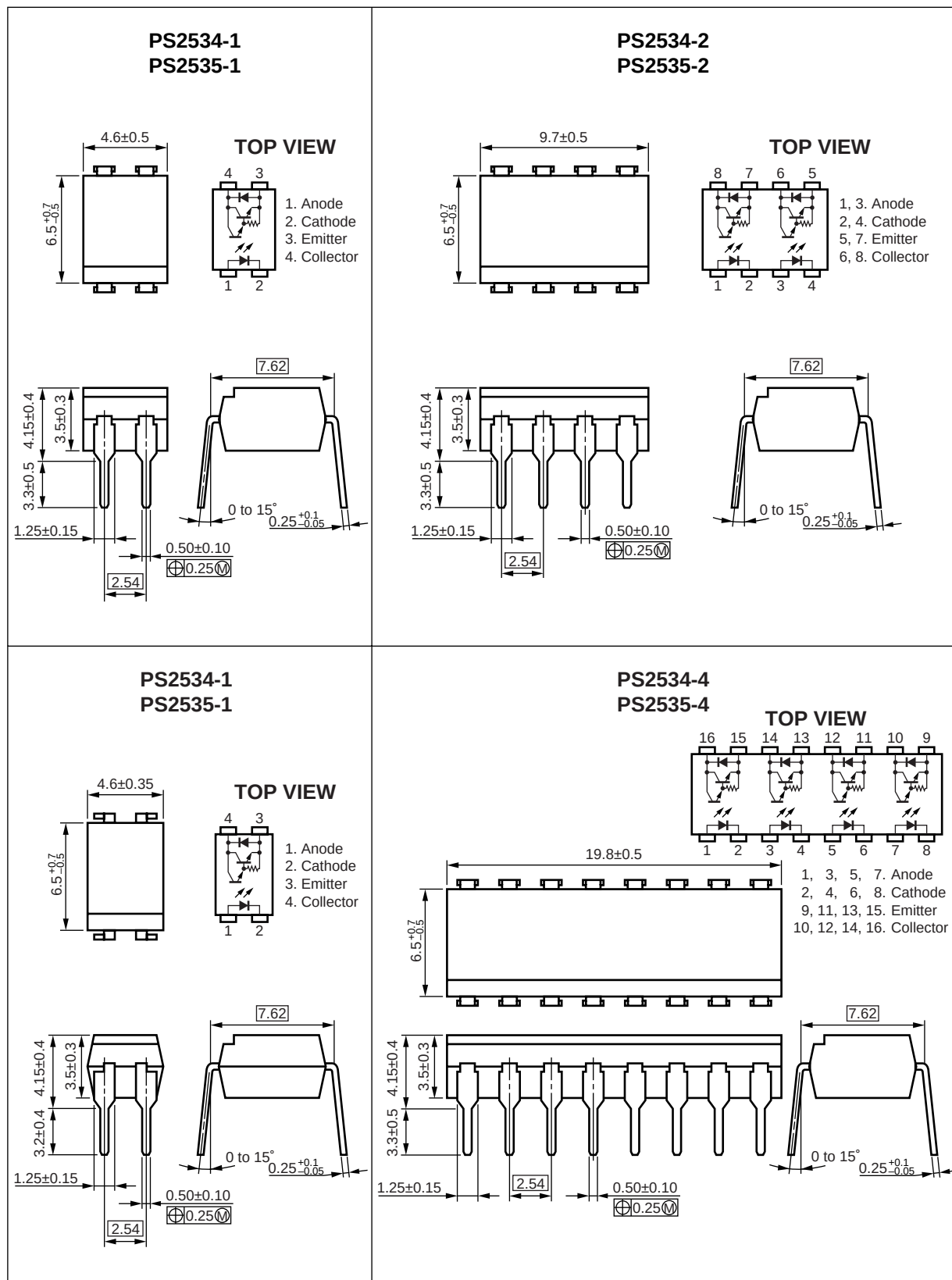
APPLICATIONS

- Telephone, Exchange equipment
- FAX/MODEM

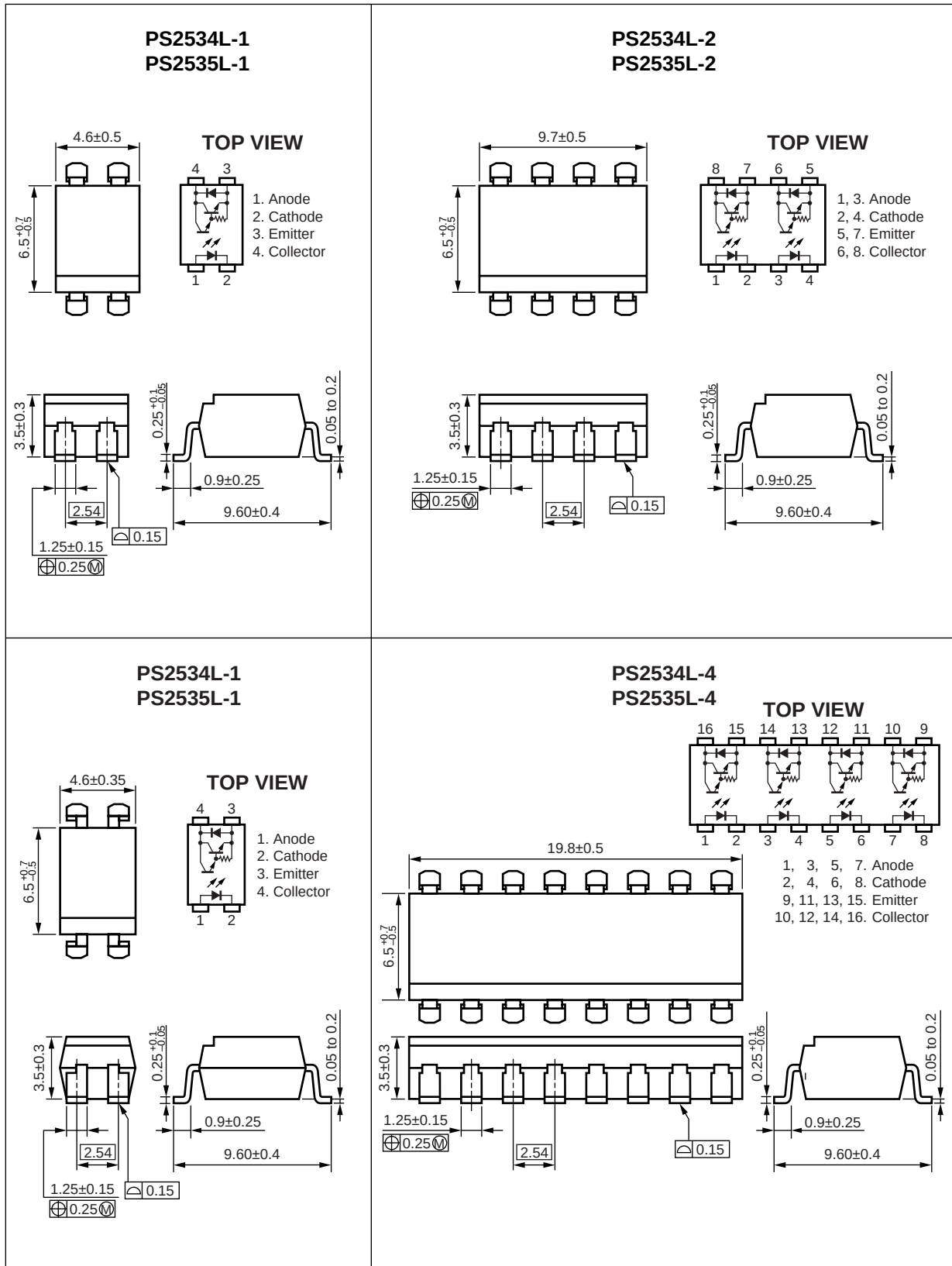
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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

PACKAGE DIMENSIONS (in millimeters)

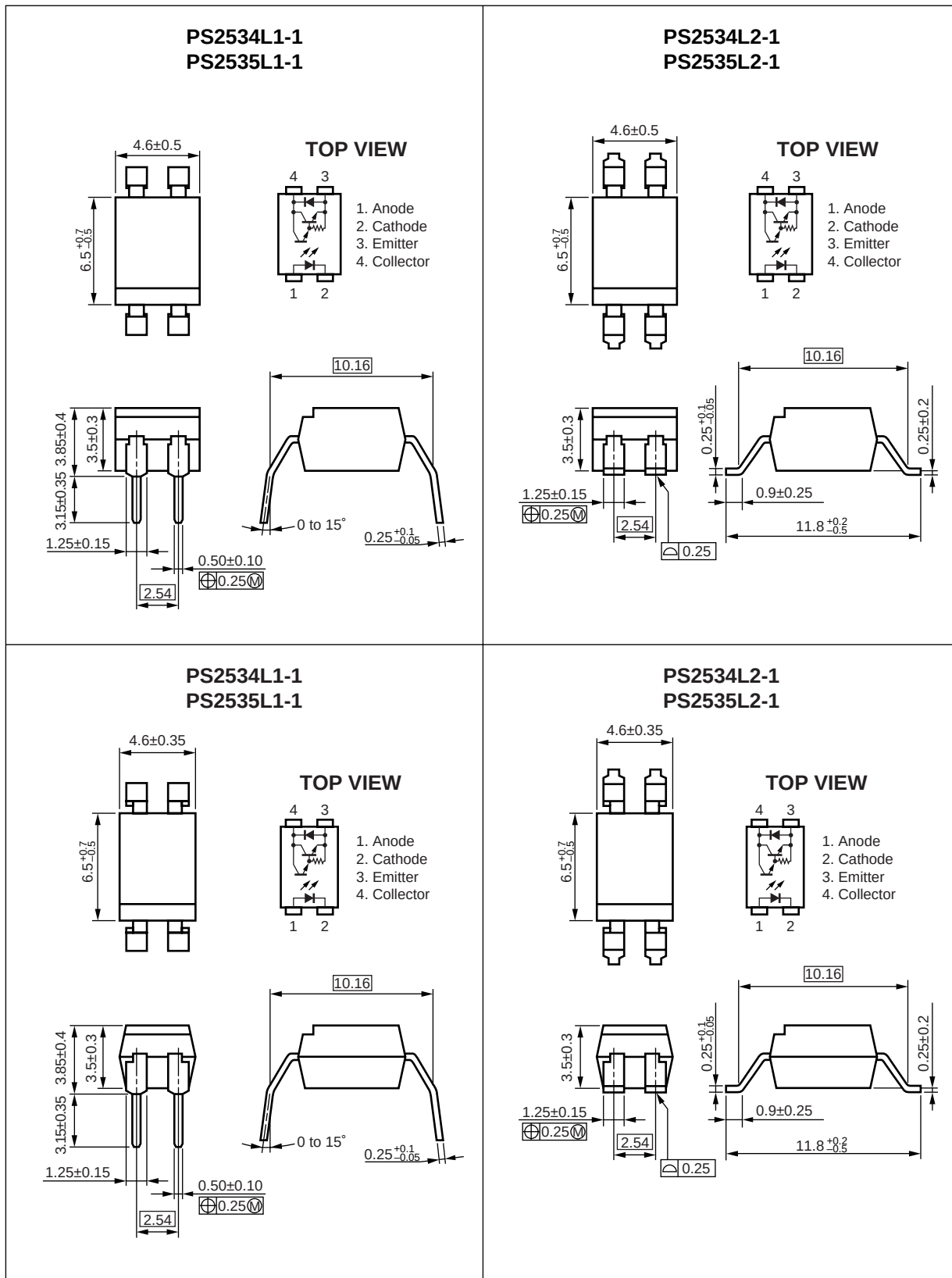
DIP type



Lead bending type



★ Lead bending type for long distance



★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS2534-1	4-pin DIP	Magazine case 100 pcs	PS2534-1
PS2534L-1			
PS2534L-1-E3		Embossed Tape 1 000 pcs/reel	
PS2534L-1-E4			
PS2534L-1-F3		Embossed Tape 2 000 pcs/reel	
PS2534L-1-F4			
PS2534-2	8-pin DIP	Magazine case 45 pcs	PS2534-2
PS2534L-2			
PS2534L-2-E3		Embossed Tape 1 000 pcs/reel	
PS2534L-2-E4			
PS2534-4	16-pin DIP	Magazine case 20 pcs	PS2534-4
PS2534L-4			
PS2535-1	4-pin DIP	Magazine case 100 pcs	PS2535-1
PS2535L-1			
PS2535L-1-E3		Embossed Tape 1 000 pcs/reel	
PS2535L-1-E4			
PS2535L-1-F3		Embossed Tape 2 000 pcs/reel	
PS2535L-1-F4			
PS2535-2	8-pin DIP	Magazine case 45 pcs	PS2535-2
PS2535L-2			
PS2535L-2-E3		Embossed Tape 1 000 pcs/reel	
PS2535L-2-E4			
PS2535-4	16-pin DIP	Magazine case 20 pcs	PS2535-4
PS2535L-4			

***1** For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings				Unit
			PS2534-1, PS2534L-1	PS2534-2, -4, PS2534L-2, -4	PS2535-1, PS2535L-1	PS2535-2, -4, PS2535L-2, -4	
Diode	Forward Current (DC)	I _F	50				mA
	Reverse Voltage	V _R	6				V
	Power Dissipation Derating	ΔP _D /°C	0.7	0.55	0.7	0.55	mW/°C
	Power Dissipation	P _D	70	55	70	55	mW/ch
	Peak Forward Current ^{*1}	I _{FP}	0.5				A
Transistor	Collector to Emitter Voltage	V _{CEO}	300		350		V
	Emitter to Collector Voltage	V _{ECO}	0.3				V
	Collector Current	I _C	100				mA/ch
	Power Dissipation Derating	ΔP _C /°C	2.0	1.6	2.0	1.6	mW/°C
	Power Dissipation	P _C	200	160	200	160	mW/ch
Isolation Voltage ^{*2}		BV	5 000				Vr.m.s.
Operating Ambient Temperature		T _A	−55 to +100				°C
Storage Temperature		T _{stg}	−55 to +150				°C

***1** PW = 100 μs, Duty Cycle = 1 %

***2** AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

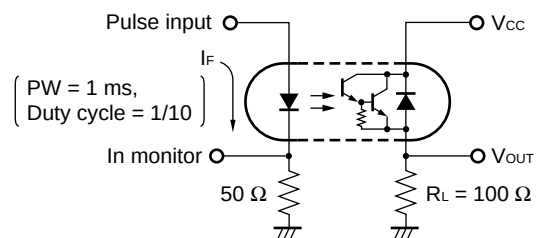
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA		1.2	1.4	V
	Reverse Current	I _R	V _R = 5 V			5	μA
	Terminal Capacitance	C _t	V = 0 V, f = 1.0 MHz		30		pF
Transistor	Collector to Emitter Dark Current	I _{CEO}	V _{CE} = 300 V, I _F = 0 mA			400	nA
Coupled	Current Transfer Ratio (I _C /I _F) ^{*1}	CTR	I _F = 1 mA, V _{CE} = 2 V	400	1 500	5 500	%
	Collector Saturation Voltage	V _{CE(sat)}	I _F = 1 mA, I _C = 2 mA			1.0	V
	Isolation Resistance	R _{I-O}	V _{I-O} = 1.0 kV _{DC}	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.6		pF
	Rise Time ^{*2}	t _r	V _{CC} = 5 V, I _C = 10 mA, R _L = 100 Ω		18		μs
	Fall Time ^{*2}	t _f			5		

*1 CTR rank (only PS2534-1, PS2535-1)

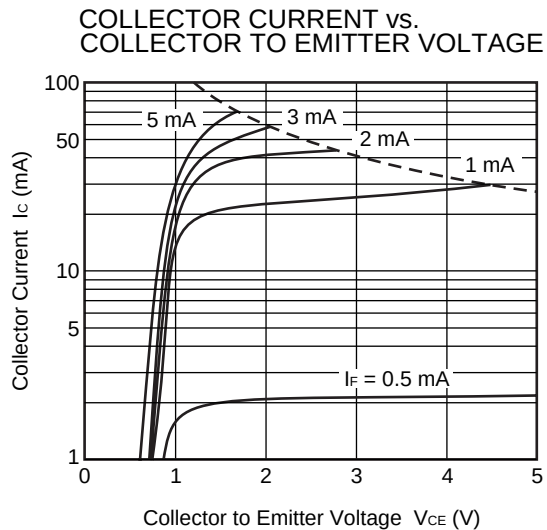
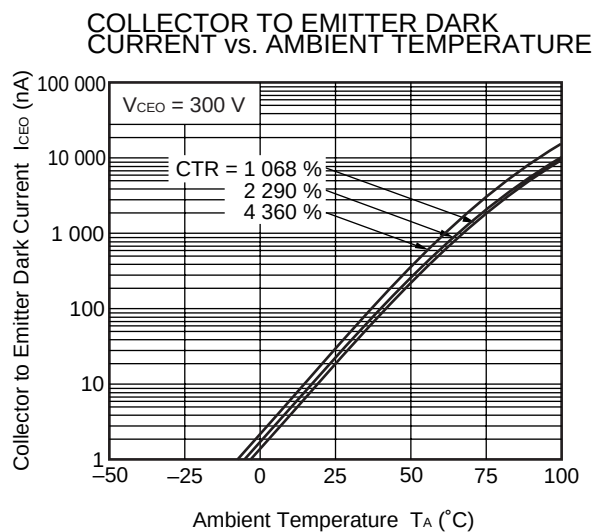
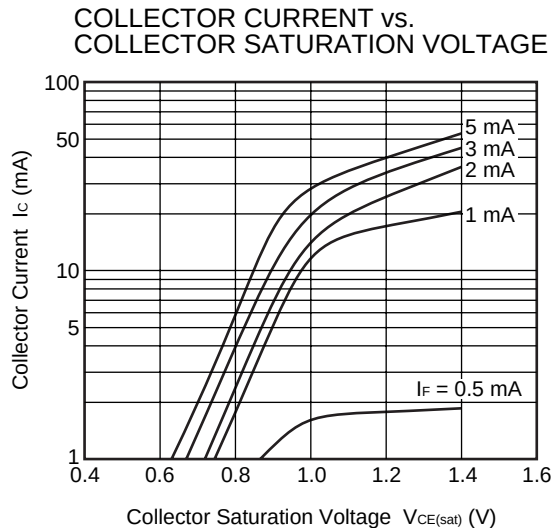
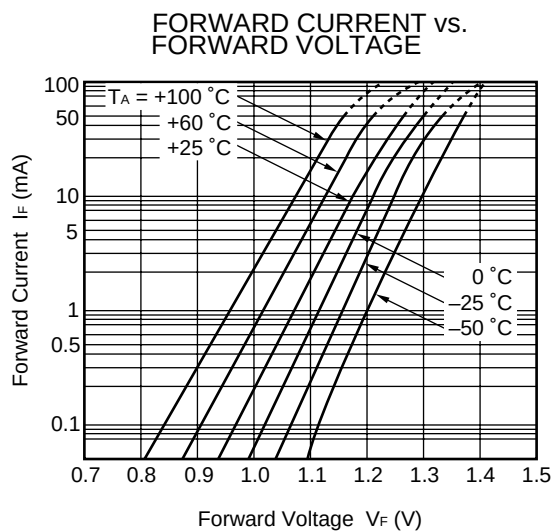
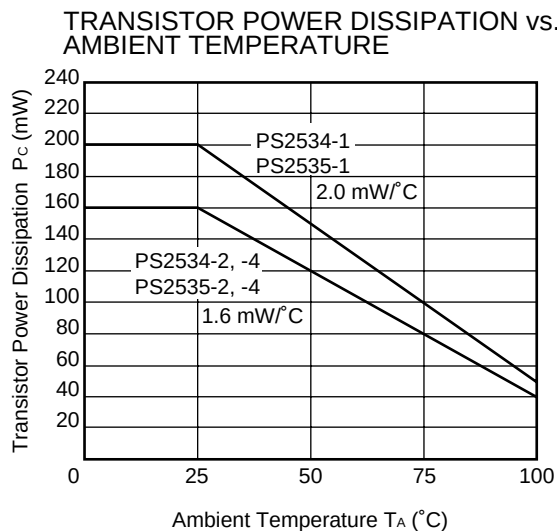
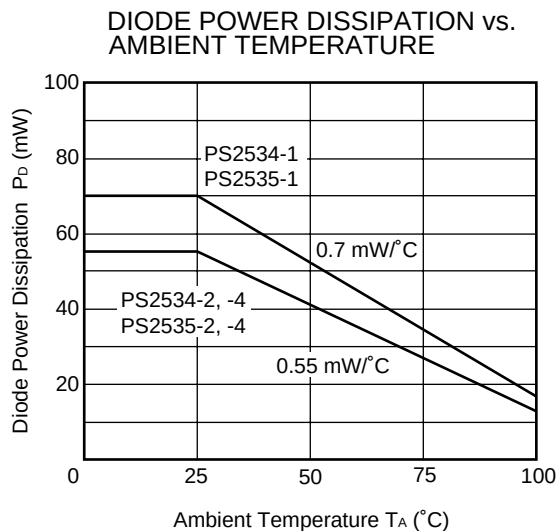
N : 400 to 5 500 (%)

L : 1 500 to 5 500 (%)

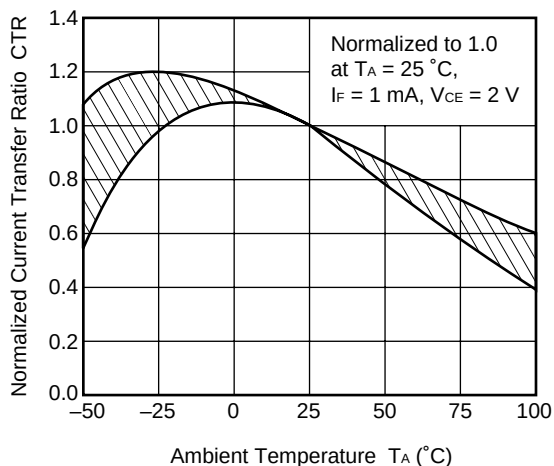
*2 Test circuit for switching time



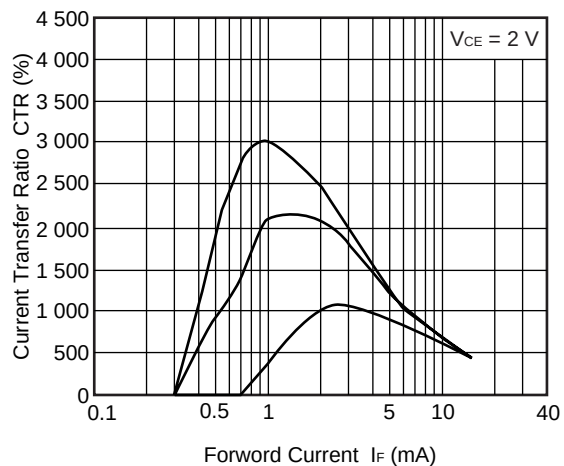
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)



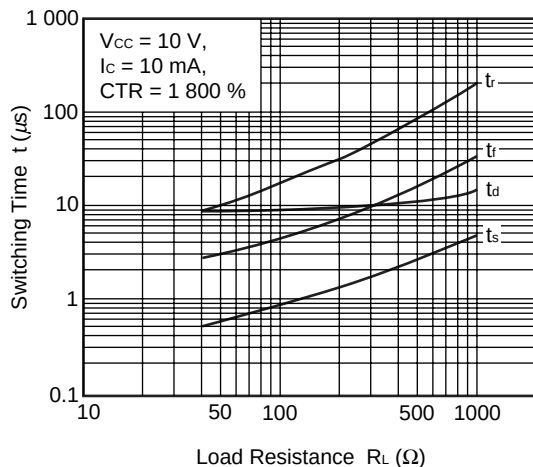
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



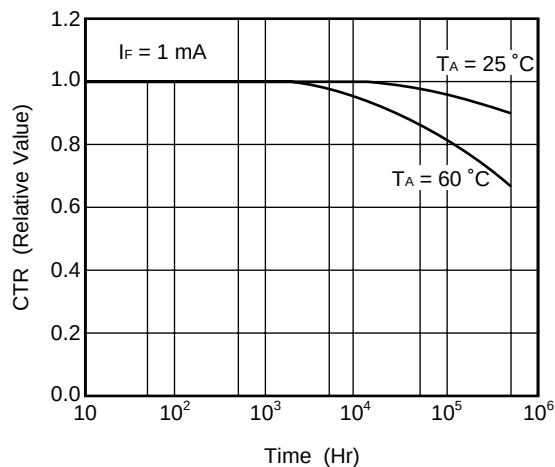
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



SWITCHING TIME vs. LOAD RESISTANCE



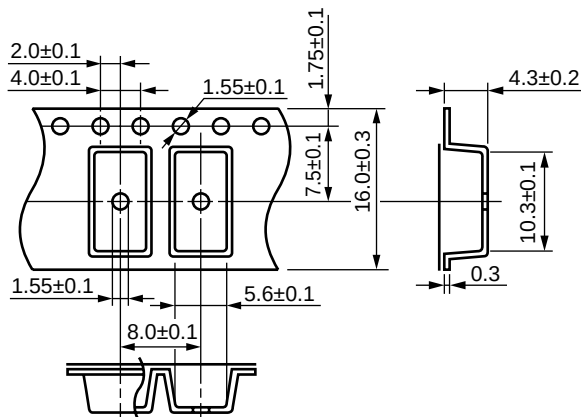
LONG TERM CTR DEGRADATION



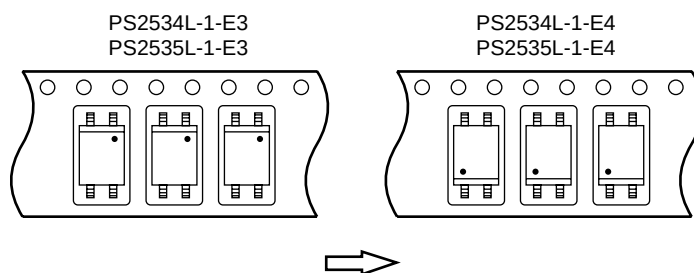
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)

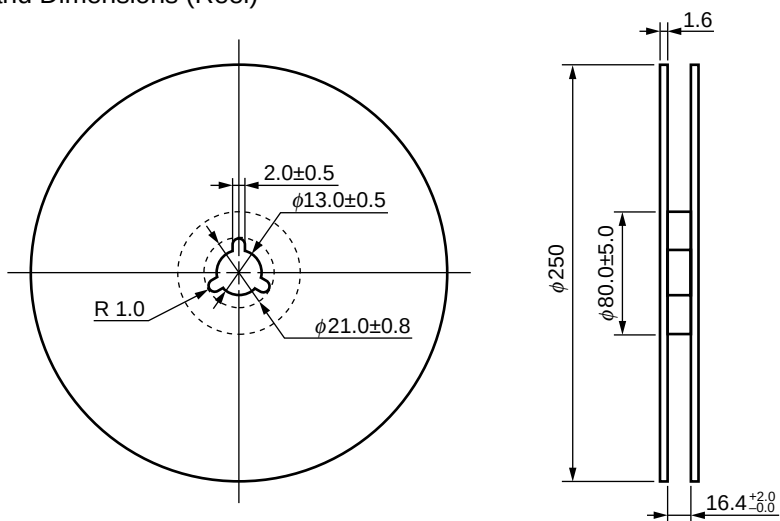
Outline and Dimensions (Tape)



Tape Direction

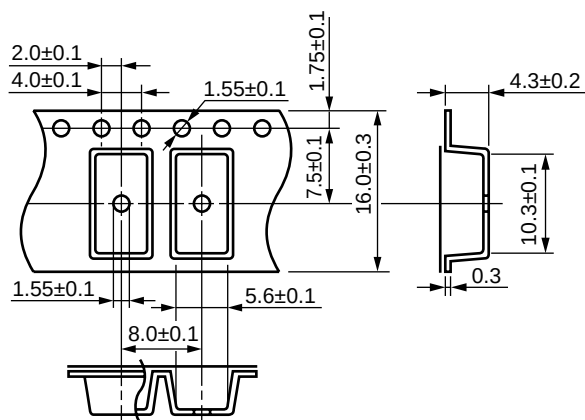


Outline and Dimensions (Reel)

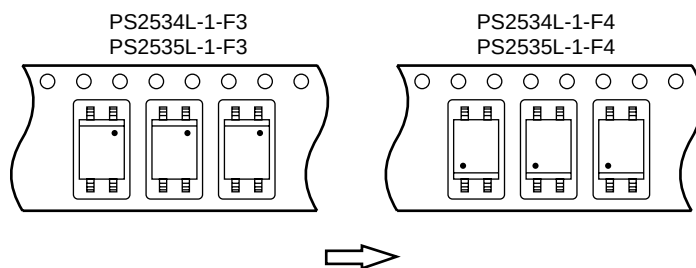


Packing: 1 000 pcs/reel

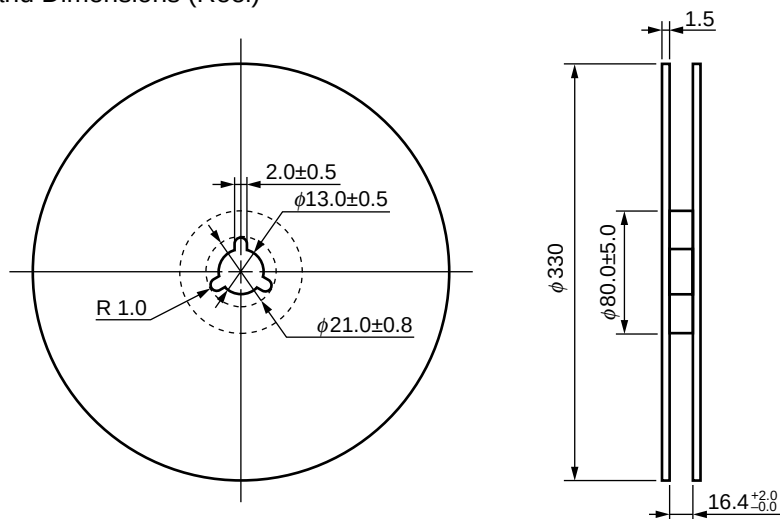
Outline and Dimensions (Tape)



Tape Direction

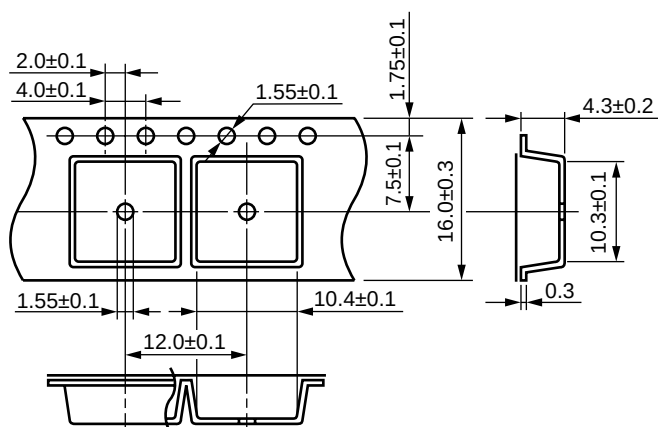


Outline and Dimensions (Reel)

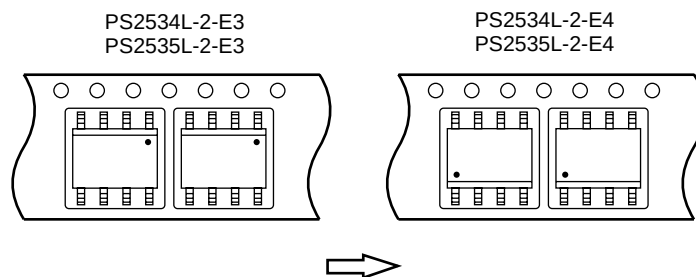


Packing: 2 000 pcs/reel

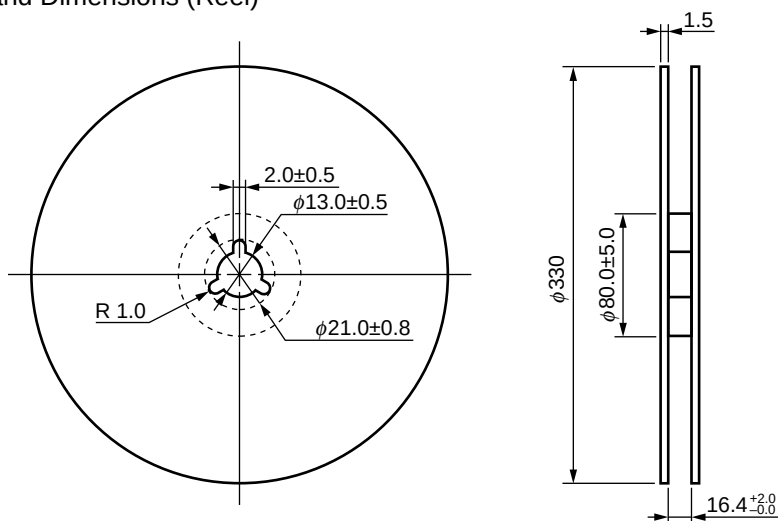
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



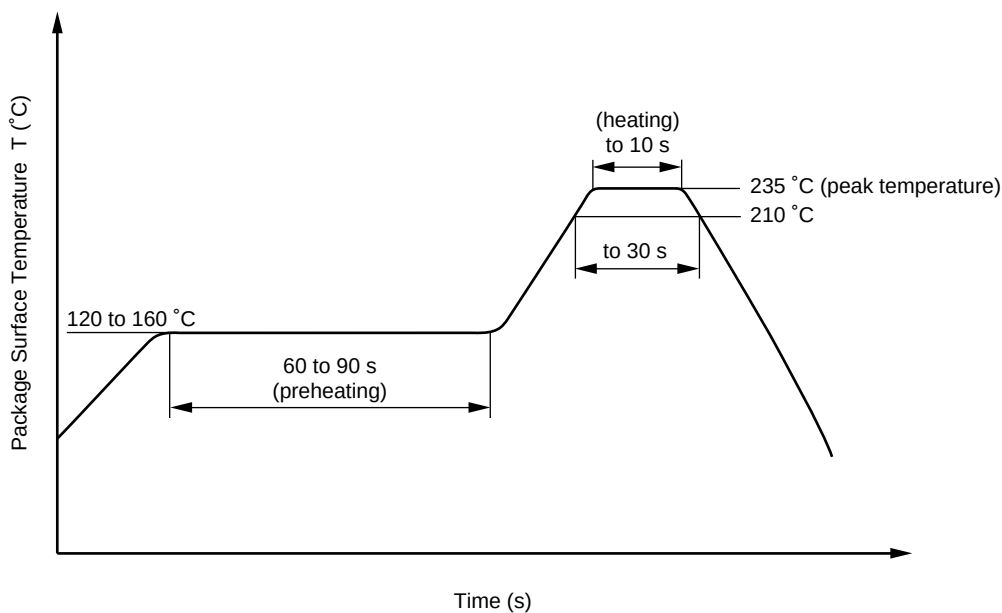
Packing: 1 000 pcs/reel

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature 235 °C (package surface temperature)
- Time of temperature higher than 210 °C 30 seconds or less
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Dip soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

- Fluxes Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

[MEMO]

[MEMO]

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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